



# FBA42060

## PFC SPM® 45 Series for 1-Phase Boost PFC

### Features

- Low Thermal Resistance Thanks to Ceramic Substrate
- 600 V - 20 A 1-Phase Boost PFC Including A Drive IC for Gate Driving and Protection
- Typical Switching Frequency of 20 kHz
- Open Emitter Terminal for IGBT Current Sensing
- Built-in NTC Thermistor for Monitoring Over-Temperature
- Isolation Rating of 2000 Vrms/min.

### Applications

- 1-Phase Boost PFC Converter for Air Conditioner

### General Description

FBA42060 is A PFC SPM 45 Series for 1-Phase Boost PFC(Power Factor Correction) that Fairchild Has Newly Developed for Low-Power Application such as Air Conditioner. It Combines Optimized Circuit Protections and Drive IC Matched to High Frequency Switching IGBT. The System Reliability is Further Enhanced by The Integrated Under-Voltage Lock-Out and Over-Current Protection Function.

### Related Source

- [Will Be Released](#)

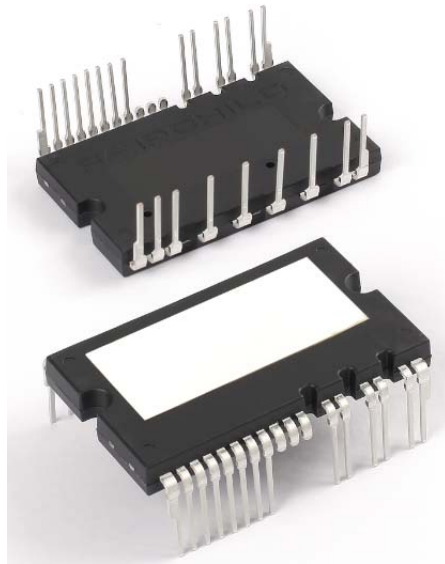


Figure 1. Package Overview

### Package Marking & Ordering Information

Device Marking	Device	Package	Packing Type	Reel Size	Tape Width	Quantity
FBA42060	FBA42060	S26AC-023	RAIL	-	-	12

### Integrated Drive, Protection and System Control Functions

- For IGBTs : Gate drive circuit, Over Current(OC) protection, Control supply circuit Under-Voltage(UV) protection
- Fault signal : Corresponding to OC and UV fault
- Built-in thermistor: Over-temperature monitoring
- Input interface : Active-high interface, can work with 3.3 / 5 V Logic

### Pin Configuration

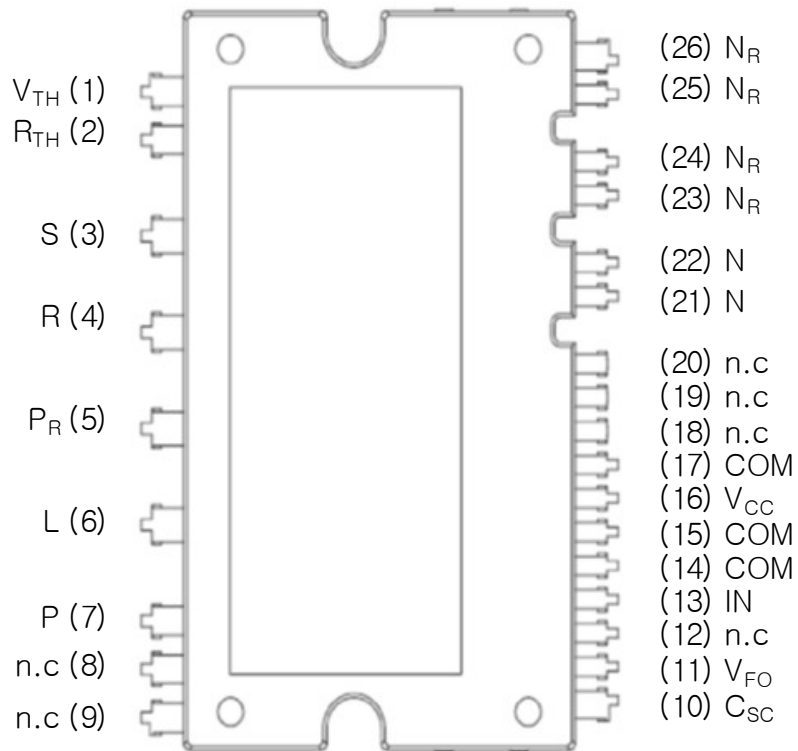


Figure 2. Top View

### Pin Descriptions

Pin Number	Pin Name	Pin Description
1	$V_{TH}$	Thermistor Bias Voltage
2	$R_{TH}$	Series Resistor for the Use of Thermistor
3	S	AC input for S phase
4	R	AC input for R phase
5	$P_R$	Positive DC-link of rectifier
6	L	Inductor Connection
7	P	Positive DC-link input
8,9	n.c	-
10	$C_{OC}$	Signal input for over current detection
11	$V_{FO}$	Fault output
12	n.c	-
13	IN	PWM input for IGBT drive
14	COM	Common supply ground
15	COM	Common supply ground
16	$V_{CC}$	Common supply voltage of IC for IGBT drive
17	COM	Common supply ground
18~20	n.c	-
21,22	N	Negative DC-link input
23~26	$N_R$	Negative DC-link of rectifier Diode

### Internal Equivalent Circuit

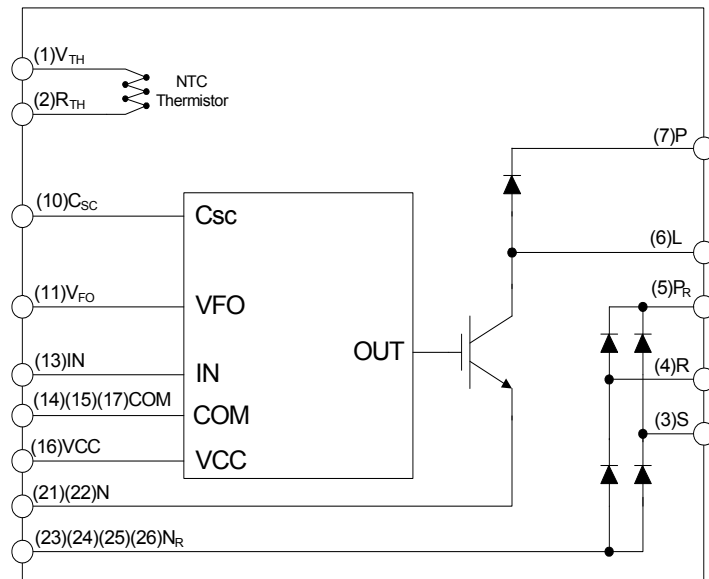


Figure 3. Internal Block Diagram

## Absolute Maximum Ratings

### Converter Part

Symbol	Parameter	Conditions	Rating	Unit
$V_i$	Input Supply Voltage	Applied between R-S	276	V
$V_{i(\text{Surge})}$	Input Supply Voltage (Surge)	Applied between R-S	500	V
$V_{PN}$	Output Voltage	Applied between P <sub>R</sub> -N <sub>R</sub>	450	V
$V_{PN(\text{Surge})}$	Output Supply Voltage (Surge)	Applied between P <sub>R</sub> -N <sub>R</sub>	500	V
$V_{CES}$	Collector-emitter Voltage		600	V
$V_{RRM}$	Repetitive Peak Reverse Voltage		600	V
$\pm I_C$	Each IGBT Collector Current	$T_C = 25^\circ\text{C}$ , $V_{CC} = 15\text{ V}$	20	A
$\pm I_{CP}$	Each IGBT Collector Current(Peak)	$T_C = 25^\circ\text{C}$ , Under 1 ms Pulse Width	30	A
$I_{FSM}$	Peak Forward Surge Current	Single Half Sine-Wave	200	A
$T_J$	Operating Junction Temperature		-40 ~ 150	°C

### Control Part

Symbol	Parameter	Conditions	Rating	Unit
$V_{CC}$	Control Supply Voltage	Applied between $V_{CC}$ - COM	20	V
$V_{IN}$	Input Signal Voltage	Applied between IN - COM	-0.3 ~ $V_{CC} + 0.3$	V
$V_{FO}$	Fault Output Supply Voltage	Applied between $V_{FO}$ - COM	-0.3 ~ $V_{CC} + 0.3$	V
$I_{FO}$	Fault Output Current	Sink Current at $V_{FO}$ Pin	1	mA
$V_{SC}$	Current Sensing Input Voltage	Applied between $C_{SC}$ - COM	-0.3 ~ $V_{CC} + 0.3$	V

### Total System

Symbol	Parameter	Conditions	Rating	Unit
$T_{STG}$	Storage Temperature		- 40 ~ 125	°C
$V_{ISO}$	Isolation Voltage	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to heat sink plate	2000	$V_{rms}$

### Thermal Resistance

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
$R_{th(j-c)Q}$	Junction to Case Thermal Resistance at Chip Center	IGBT	-	-	2.5	°C/W
$R_{th(j-c)D}$		FRD	-	-	2.5	°C/W
$R_{th(j-c)R}$		Rectifier	-	-	2.5	°C/W

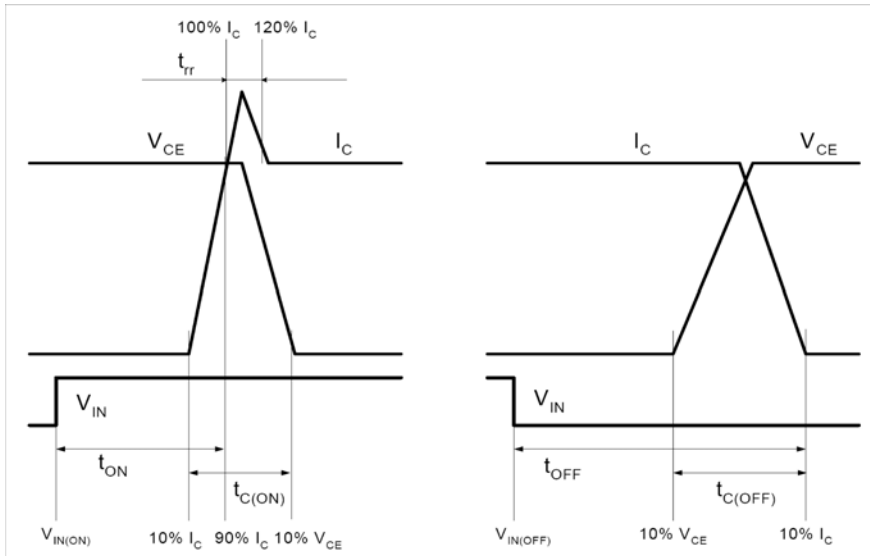
## Electrical Characteristics (T<sub>J</sub> = 25°C, Unless Otherwise Specified)

### Converter Part

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V <sub>CE(SAT)</sub>	IGBT Collector-Emitter Saturation Voltage	V <sub>CC</sub> = 15 V, V <sub>IN</sub> = 5V, I <sub>C</sub> = 20 A	-	2.2	2.7	V
V <sub>FF</sub>	FRD Forward Voltage	I <sub>F</sub> = 20 A	-	2.1	2.6	V
V <sub>FR</sub>	Rectifier Forward Voltage	I <sub>F</sub> = 20 A	-	1.1	1.4	V
t <sub>ON</sub>	Switching characteristic	V <sub>PN</sub> = 300 V, V <sub>CC</sub> = 15 V, I <sub>C</sub> = 20 A, V <sub>IN</sub> = 0 V ↔ 5 V, Inductive Load (Note 1)	-	770	-	μs
t <sub>OFF</sub>			-	640	-	μs
t <sub>C(ON)</sub>			-	130	-	μs
t <sub>C(OFF)</sub>			-	50	-	μs
t <sub>rr</sub>			-	40	-	μJ
I <sub>rr</sub>			-	4.0	-	μJ
I <sub>CES</sub>			Collector-Emitter Leakage Current	V <sub>CE</sub> = V <sub>CES</sub>	-	-

**Note:**

- t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. t<sub>C(ON)</sub> and t<sub>C(OFF)</sub> are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Figure 4.



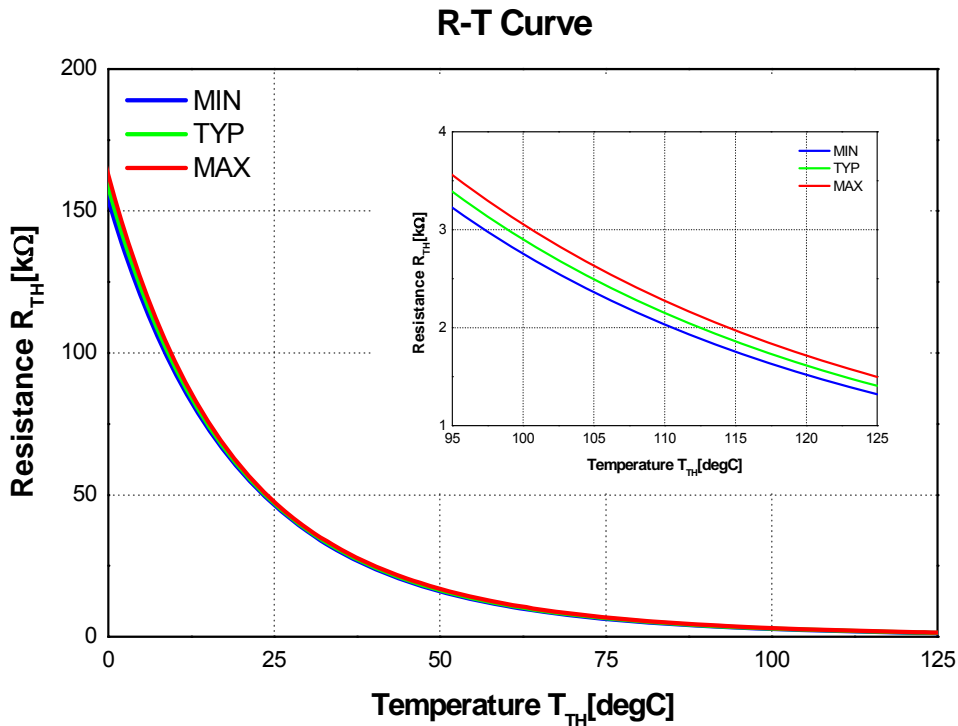
**Figure 4. Switching Time Definitions**

**Control Part**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_{OCC}$	Quiescent $V_{CC}$ Supply Current	$V_{CC} = 15\text{ V}$ , $V_{IN} = 0\text{ V}$ , $V_{CC} - \text{COM}$	-	-	2.65	mA
$V_{FOH}$	Fault Output Voltage	$V_{SC} = 0\text{ V}$ , $V_{FO}$ Circuit: 4.7 k $\Omega$ to 5 V Pull-up	4.5	-	-	V
$V_{FOL}$		$V_{SC} = 1\text{ V}$ , $V_{FO}$ Circuit: 4.7 k $\Omega$ to 5 V Pull-up	-	-	0.8	V
$V_{SC(\text{ref})}$	Over-Current Protection Trip Level Voltage of $C_{SC}$ pin	$V_{CC} = 15\text{ V}$ (Note 2)	0.45	0.5	0.55	V
$UV_{CCD}$	Supply Circuit Under-Voltage Protection	Detection Level	10.5	-	13.0	V
$UV_{CCR}$		Reset Level	11.0	-	13.5	V
$V_{IN(\text{ON})}$	ON Threshold Voltage	Applied between IN - COM	-	-	2.6	V
$V_{IN(\text{OFF})}$	OFF Threshold Voltage		0.8	-	-	V
$R_{TH}$	Resistance of Thermistor	$T_{TH} = 25^\circ\text{C}$ (Note 3)	-	47.0	-	k $\Omega$
		$T_{TH} = 100^\circ\text{C}$	-	2.9	-	k $\Omega$

**Note:**

- Over-current protection is functioning on IGBT.
- $T_{TH}$  is the temperature of thermistor itself. To know case temperature ( $T_c$ ), please make the experiment considering your application.



**Figure 5. R-T Curve of The Built-in Thermistor**

### Recommended Operating Conditions

Symbol	Parameter	Conditions	Value			Units
			Min.	Typ.	Max.	
$V_i$	Input Supply Voltage	Applied between R - S	198	220	242	$V_{rms}$
$V_{PN}$	Supply Voltage	Applied between $P_R$ - N	-	360	400	V
$I_i$	Input Current	$V_{DC} = 360\text{ V}$ , $F_{SW} = 20\text{ kHz}$ , $V_{CC} = 15\text{ V}$ , $T_C = 90^\circ\text{C}$ , $T_J \leq 150^\circ\text{C}$	-	20	-	$A_{peak}$
$V_{CC}$	Supply Voltage for inverter	Applied between $V_{CC}$ - COM	13.5	15	16.5	V
$P_{WIN(ON)}$	Minimum Input Pulse Width	(Note 4)	0.5	-	-	$\mu\text{s}$
$P_{WIN(OFF)}$			0.5	-	-	$\mu\text{s}$
$dV_{CC}/dt$	Supply Variation		-1	-	1	$V/\mu\text{s}$
$f_{PWM}$	PWM Input Frequency	$T_J \leq 150^\circ\text{C}$	-	20	-	kHz
$V_{SEN}$	Voltage for Current Sensing	Applied between N - COM (Including surge voltage)	-4	-	4	V

Note:

4. The PFC SPM® product might not make response if input pulse width is less than the recommended value.

### Mechanical Characteristics and Ratings

Parameter	Conditions		Limits			Units
			Min.	Typ.	Max.	
Mounting Torque	Mounting Screw: M3	Recommended 0.7 N•m	0.6	0.7	0.8	N•m
Device Flatness		Refer to Figure 6	0	-	+120	$\mu\text{m}$
Weight			-	11	-	g

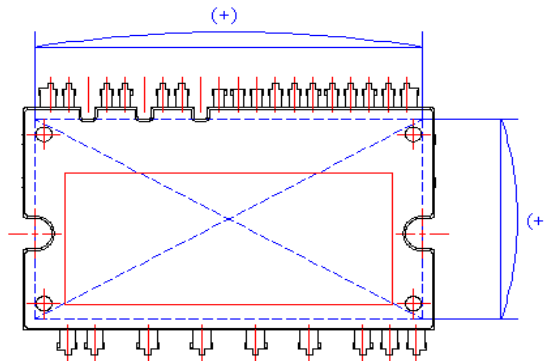
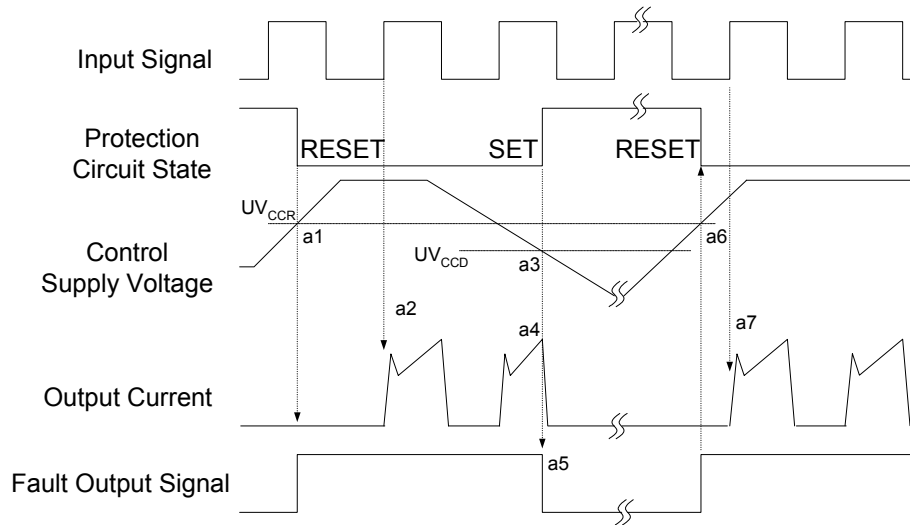


Figure 6. Flatness Measurement Position

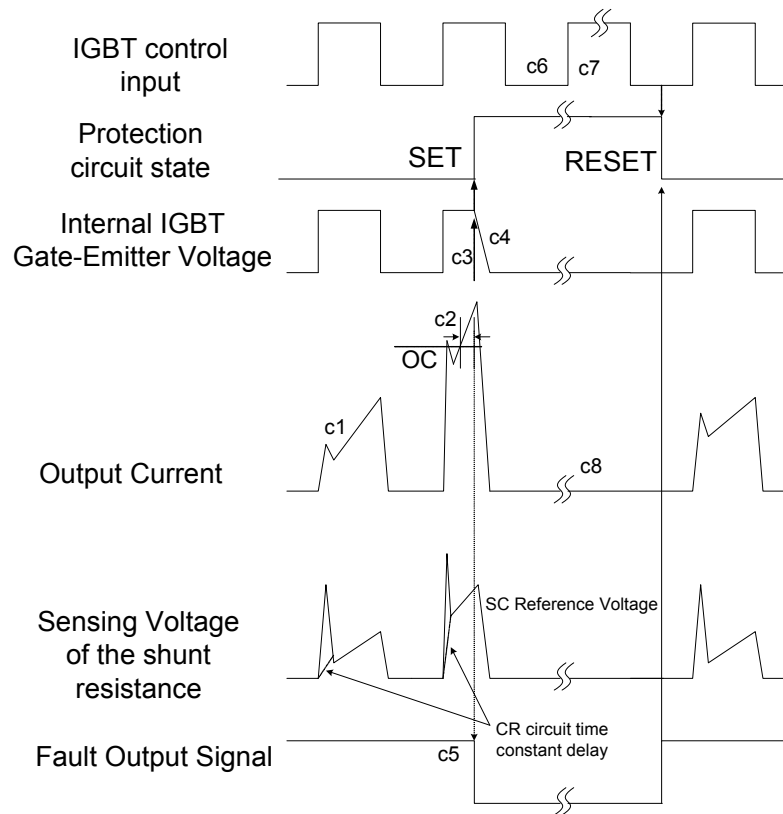
### Time Charts of PFC SPM®'s Protective Function



- a1 : Control supply voltage rises: After the voltage rises  $UV_{CCR}$ , the circuits start to operate when the next input is applied.
- a2 : Normal operation: IGBT ON and carrying current.
- a3 : Under voltage detection ( $UV_{CCD}$ ).
- a4 : IGBT OFF in spite of control input condition.
- a5 : Fault output operation starts.
- a6 : Under voltage reset ( $UV_{CCR}$ ).
- a7 : Normal operation: IGBT ON and carrying current.

**Figure 7. Under-Voltage Protection**



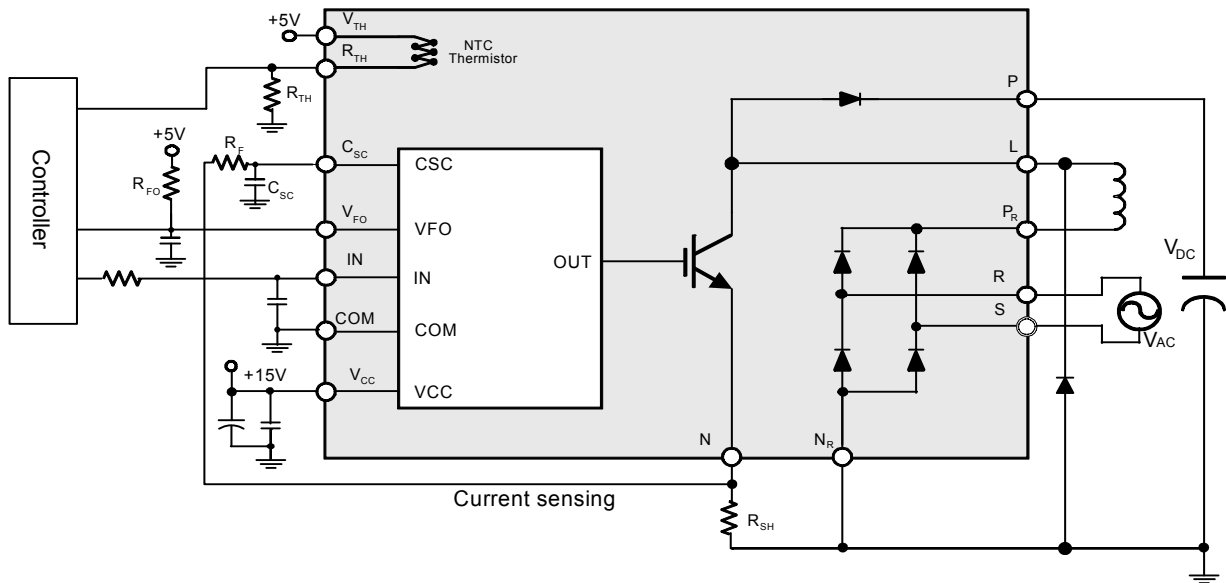


(with the external shunt resistance and CR connection)

- c1 : Normal operation: IGBT ON and carrying current.
- c2 : Over current detection (OC trigger).
- c3 : Hard IGBT gate interrupt.
- c4 : IGBT turns OFF.
- c5 : Fault output timer operation starts.
- c6 : Input "L" : IGBT OFF state.
- c7 : Input "H": IGBT ON state, but during the active period of fault output the IGBT doesn't turn ON.
- c8 : IGBT OFF state

**Figure 8. Over Current Protection**

## Recommand circuit for Application

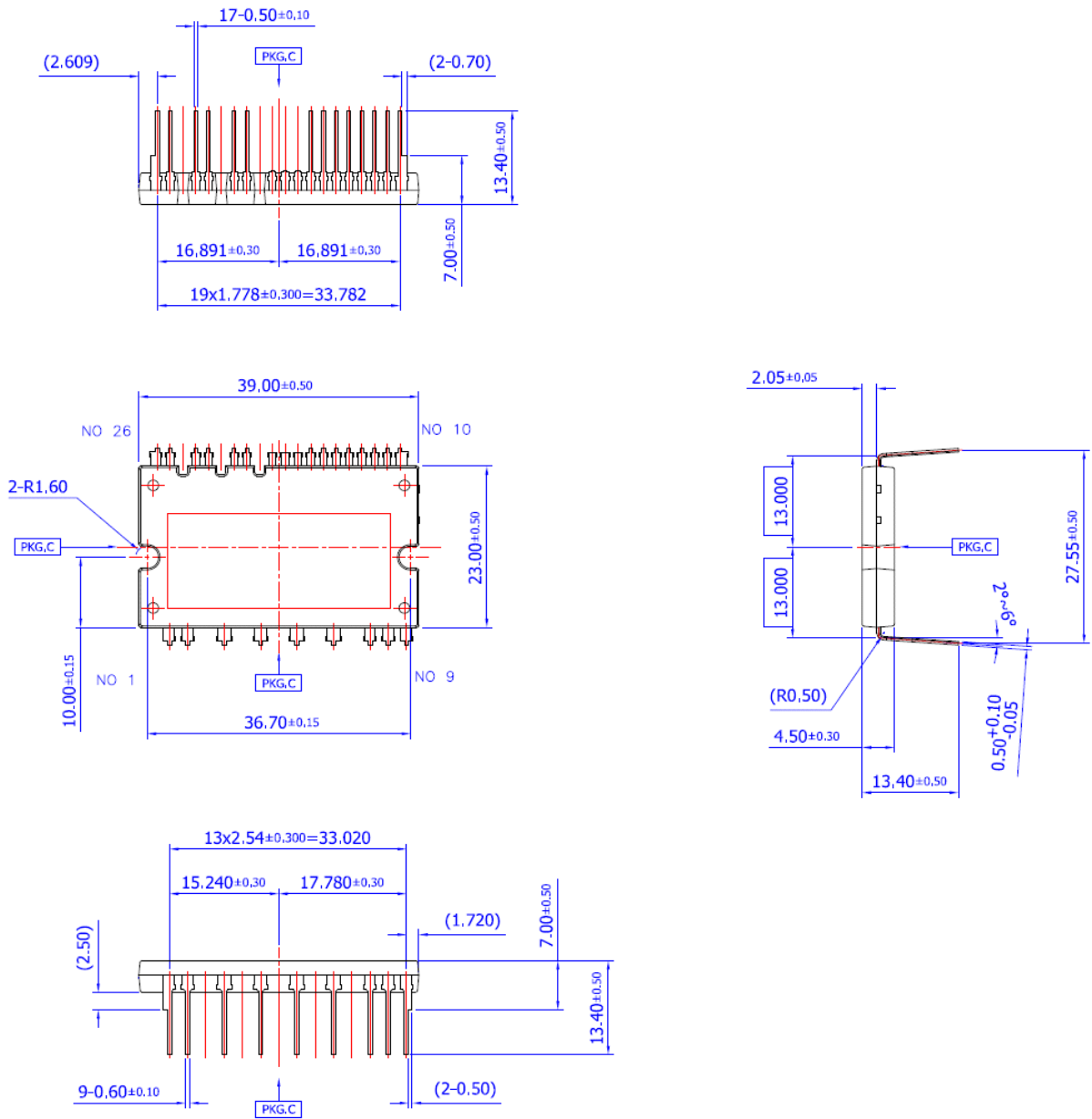


### Note:

1. To avoid malfunction, the wiring of each input should be as short as possible. (less than 2-3cm)
2.  $V_{FO}$  output is open collector type. This signal line should be pulled up to the positive side of the 5V power supply with approximately 4.7k $\Omega$  resistance.
3. Input signal is High-Active type. There is a 3.3 k $\Omega$  resistor inside the IC to pull down each input signal line to GND. When employing RC coupling circuits, set up such RC couple that input signal agree with turn-off/turn-on threshold voltage.
4. To prevent errors of the protection function, the wiring around  $R_F$  and  $C_{SC}$  should be as short as possible.
5. In the over current protection circuit, please select the  $R_F$ ,  $C_{SC}$  time constant in the range 1~2  $\mu$ s.
6. Each capacitors should be mounted as close to the pins as possible.
7. Relays are used at almost every systems of electrical equipments of home appliances. In these cases, there should be sufficient distance between the CPU and the relays.
8. Internal NTC thermistor can be used for monitoring the case temperature and protecting the device from the overheating operation. Please select an appropriate resistor  $R_{TH}$  according to the application. For example, use  $R_{TH}=4.7$  k $\Omega$  that will make the voltage across  $R_{TH}$  to be 2.5V at 85°C of the case temperature.
9. Please use an appropriate shunt resistor  $R_{SH}$  to protect the internal IGBT from the overcurrent operation.
10. It's recommended that anti-parallel diode should be connected with IGBT.

**Figure 9. Typical Application Circuit**

Detailed Package Outline Drawings



Dimension unit: millimeter



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| FACT®  | MotionMax™                                     | SupreMOS®  | VCX™  |
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